



## Material Content Data Sheet



Halogen-Free

<b>Sales Product Name</b>	IPP120N04S4-02	<b>Issued</b>	04. May 2021
<b>MA#</b>	MA001043560		
<b>Package</b>	PG-TO220-3-1	<b>Weight*</b>	2039.44 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	4.984	0.24	0.24	2444	2444
leadframe	inorganic material	phosphorus	7723-14-0	0.245	0.01		120	
	non noble metal	iron	7439-89-6	0.816	0.04		400	
	non noble metal	copper	7440-50-8	815.335	40.00	40.05	399784	400304
wire	non noble metal	aluminium	7429-90-5	13.700	0.67	0.67	6717	6717
encapsulation	inorganic material	zinc oxide	1314-13-2	5.886	0.29		2886	
	miscellaneous	miscellaneous	-	23.546	1.15		11545	
	plastics	epoxy resin	-	88.297	4.33		43295	
	inorganic material	silicon dioxide	60676-86-0	470.917	23.09	28.86	230905	288631
lead finish	non noble metal	tin	7440-31-5	21.462	1.05	1.05	10524	10524
plating	inorganic material	phosphorus	7723-14-0	0.001			1	
	non noble metal	nickel	7440-02-0	0.244	0.01	0.01	120	121
solder	non noble metal	tin	7440-31-5	0.075			37	
	noble metal	silver	7440-22-4	0.094			46	
	non noble metal	lead	7439-92-1	3.604	0.18	0.18	1767	1850
heatspreader	inorganic material	phosphorus	7723-14-0	0.177	0.01		87	
	non noble metal	iron	7439-89-6	0.590	0.03		289	
	non noble metal	copper	7440-50-8	589.466	28.90	28.94	289033	289409
*deviation	< 10%	Sum in total:				100.00		1000000

### Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

Company	Infineon Technologies AG
Address	81726 Neubiberg
Internet	www.infineon.com